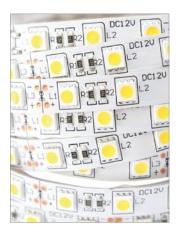


Umicore Electroplating

UMICORE SEALING 691 EL



Protection for Technical Precious Metal Surfaces

Umicore Sealing 691 EL is a perfect all-rounder to protect technical precious metal surfaces including electrical contacts. The coefficient of friction will be reduced enormously, the sliding performance of connectors will be improved, and even under strong mechanical stress, the functional layer is protected for much longer. In addition, Umicore Sealing 691 EL prevents tarnishing and discolouring. Silver surfaces treated with Umicore Sealing 691 EL as a final layer produce outstanding results in K₂S tests.

There are no disadvantages in using Umicore Sealing 691 EL: Electrical characteristics are unchanged, and solderability and contact resistance are unaffected. In addition, Umicore Sealing 691 EL is easy to use: either in a simple dipping process or by electrolytic application for very short contact times in reel-to-reel plating. Finally, Umicore Sealing 691 EL is free of chromium and doesn't contain environmentally harmful substances like CFCs, CHCs and HCs.



Advantages

- Especially developed for technical components like electrical contacts
- Very short treatment times, making it suitable for reel-to-reel plating
- Long-lasting protection against tarnishing and discolouration
- Easy to use, both electrolytic and dipping process
- Free of components like CFCs, CHCs, HCs and chrome
- No influence on colour or brightness of the finished coating
- · Increased sliding performance, reduced insertion force
- Provides high reliability in K_2S test, therefore a perfect protection for silver layers

Applications

- Connectors
- Lead frames
- Smartcards

UMICORE SEALING 691 EL



No influence

No influence

Reduced

Improved

< 10 mΩ

No influence

Protected parts

remain bondable

TECHNICAL SPECIFICATIONS

Electro	yte c	haracteristics

Electrolyte type	Aqueous, metalfree passivation
pH value	Weakly acidic to neutral
Operating temperature	55 (48 - 52) °C
Immersion time Rack/barrel Reel-to-reel	30 (10 - 120) s 5 (2 - 10) s
Anode material	MMO (type PLATINODE® 187 SO)

Umicore Sealing 691 Reduces Friction Forde Friction Marks After 500 Friciton Cycles

COF (coefficient of friction)



COF: 0.76



Pure silver with Umicore Sealing 691

COF: 0.04

Excellent Silver Passivation

K_sS Test 2% and 5 % Until Discoloration Appears

K₃S 2% 3 min.





10 sec. / 5 V electrolytic version



K₂S 5% 5 min.

10 sec. / 5 V

electrolytic

version

0.05 µm Au without Sealing

Colour

Brightness

Coefficient of friction

Sliding properties

Contact resistance

Stable Contact Resistance

Solderability

Bondability

on silver

Contact resistance [mΩ]

10

5

0

VS.

0.05 µm Au with Sealing



Dip time in Umicore Sealing 691 [s]

without Sealing

Excellent Resistance in Salt Spray Test

72h NSS Test (Ni/Au Plated)

0.4 µm Au without Sealing

with Sealing

VS. 0.4 µm Au

Coating characteristics

Dip Time vs Contact Resistance at Contact Normal Force 50 cN

10



YOUR CONTACT

Do you have a specific question or would you like a no-obligation quote calculation? Our specialist will be happy to help you with any technical questions you might have.



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